



Solid State Relay OCMOS FET

# **PS7241E-1B**

## 4-PIN SOP 400 V BREAK DOWN VOLTAGE NORMALLY CLOSE TYPE 1-ch Optical Coupled MOS FET

-NEPOC Series-

### **DESCRIPTION**

The PS7241E-1B is an optically coupled element that combines a GaAs infrared LED on the input side with a normally close MOS FET on the output side to realize an excellent cost performance.

The small, thin package and high sensitivity of this element makes it ideal for battery-driven mobile devices, and its small offset voltage at power-on and good linearity also make it suitable for controlling micro analog signals.

### **FEATURES**

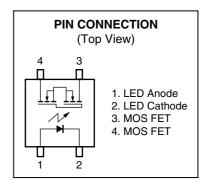
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- 1 channel type (1 b output)
- Low LED operating current (IF = 3 mA)
- · Designed for AC/DC switching line changer
- Low offset voltage
- Ordering number of taping product: PS7241E-1B-E3, E4, F3, F4
- · Pb-Free product

<R> • Safety standards

UL approved: File No. E72422BSI approved: File No. 8241/8242

### **APPLICATIONS**

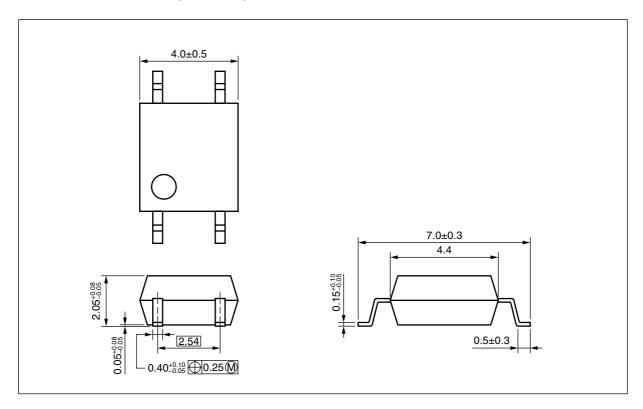
- · Laptop PC, PDA
- Modem card
- Telephone, FAX
- · Measurement equipment



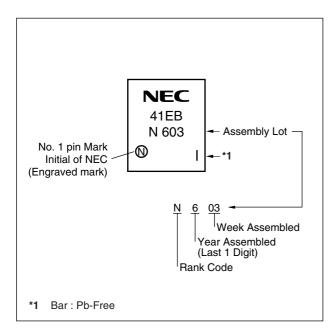
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## PACKAGE DIMENSIONS (UNIT: mm)



### **MARKING EXAMPLE**





## <R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>∸1</sup>
PS7241E-1B	PS7241E-1B-A	Pb-Free	Magazine case 100 pcs	Standard products	PS7241E-1B
PS7241E-1B-E3	PS7241E-1B-E3-A		Embossed Tape 900 pcs/reel	(UL, BSI approved)	
PS7241E-1B-E4	PS7241E-1B-E4-A				
PS7241E-1B-F3	PS7241E-1B-F3-A		Embossed Tape 3 500 pcs/reel		
PS7241E-1B-F4	PS7241E-1B-F4-A				

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation	Po	50	mW
	Peak Forward Current <sup>™</sup>	<b>I</b> FP	1	Α
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	lι	120	mA
	Pulse Load Current <sup>*2</sup> (AC/DC Connection)	ILP	240	mA
	Power Dissipation	Po	300	mW
Isolation Voltage*3		BV	1 500	Vr.m.s.
Total Power Dissipation		Рт	350	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		T <sub>stg</sub>	-40 to +100	°C

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1%

<sup>\*2</sup> PW = 100 ms, 1 shot

<sup>\*3</sup> AC voltage for 1 minute at  $T_A = 25^{\circ}C$ , RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.



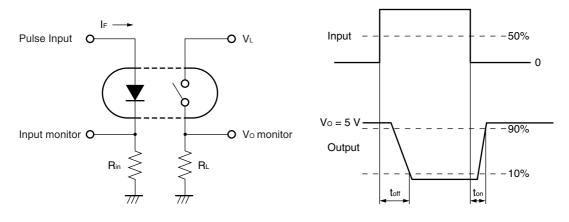
## RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	3	10	20	mA
LED Off Voltage	VF	0		0.5	V

## **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	٧
	Reverse Current	lr	V <sub>R</sub> = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	Loff	IF = 10 mA, VD = 400 V		0.03	1.0	μΑ
	Output Capacitance	Cout	IF = 10 mA, VD = 0 V, f = 1 MHz		206		pF
Coupled	LED Off-state Current	<b>I</b> Foff	I∟ = 120 mA			3.0	mA
	On-state Resistance	R <sub>on1</sub>	I <sub>F</sub> = 0 mA, I <sub>L</sub> = 10 mA		22	35	Ω
		Ron2	$I_F = 0 \text{ mA}, I_L = 120 \text{ mA}, t \le 10 \text{ ms}$		17	24	
	Turn-on Time*1,2	ton	If = 10 mA, Vo = 5 V, RL = 500 $\Omega$ ,		0.07	0.2	ms
	Turn-off Time*1,2	<b>t</b> off	PW ≥ 10 ms		1.0	3.0	
	Isolation Resistance	R <sub>I-O</sub>	Vi-o = 1.0 kVpc	10°			Ω
	Isolation Capacitance	С-о	V = 0 V, f = 1 MHz		0.5		pF

## \*1 Test Circuit for Switching Time



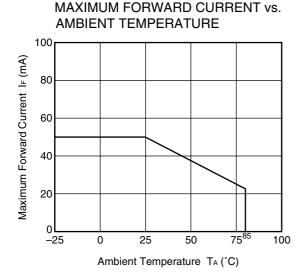
<R>

\*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.

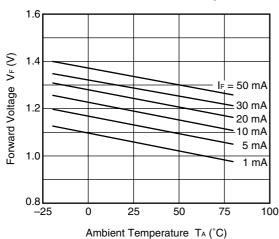
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.



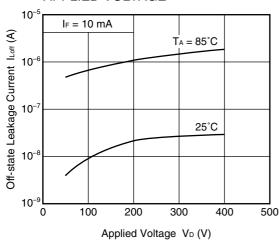
#### <R> TYPICAL CHARACTERISTICS (Ta = 25°C, unless otherwise specified)





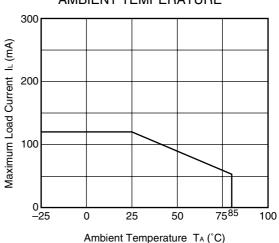


### OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE

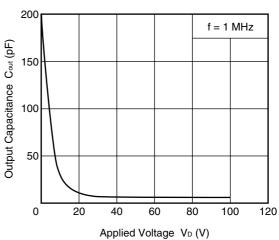


Remark The graphs indicate nominal characteristics.

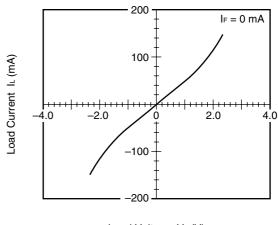
### MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



### **OUTPUT CAPACITANCE vs.** APPLIED VOLTAGE



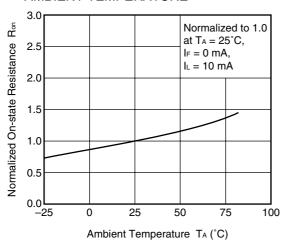
### LOAD CURRENT vs. LOAD VOLTAGE



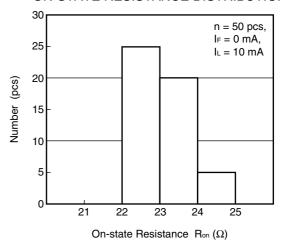
Load Voltage V<sub>L</sub> (V)



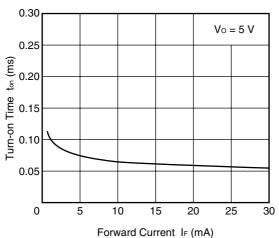
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



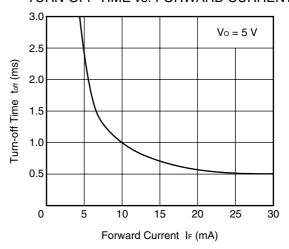
### **ON-STATE RESISTANCE DISTRIBUTION**



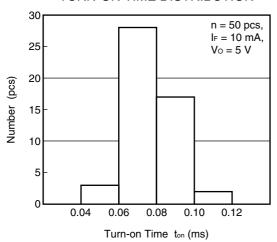
### TURN-ON TIME vs. FORWARD CURRENT



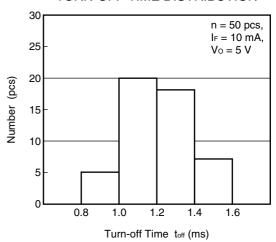
### TURN-OFF TIME vs. FORWARD CURRENT



### **TURN-ON TIME DISTRIBUTION**



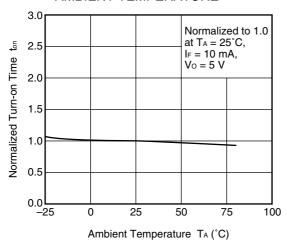
TURN-OFF TIME DISTRIBUTION



Remark The graphs indicate nominal characteristics.

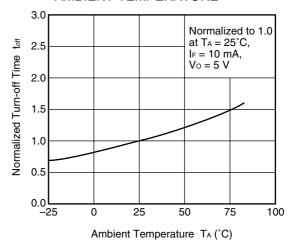


## NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE



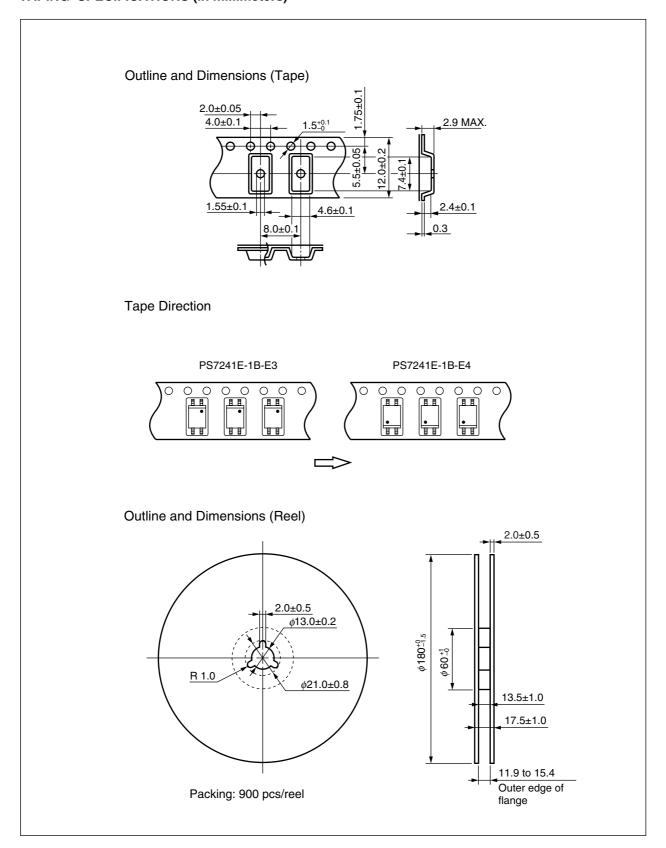
**Remark** The graphs indicate nominal characteristics.

## NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



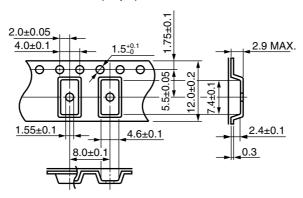


## **TAPING SPECIFICATIONS (in millimeters)**

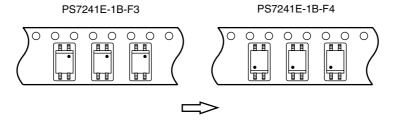




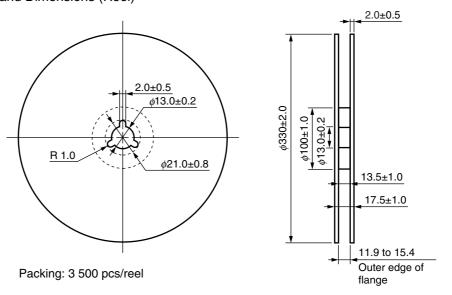
## Outline and Dimensions (Tape)



**Tape Direction** 



## Outline and Dimensions (Reel)





### RECOMMENDED SOLDERING CONDITIONS

### (1) Infrared reflow soldering

260°C or below (package surface temperature) · Peak reflow temperature

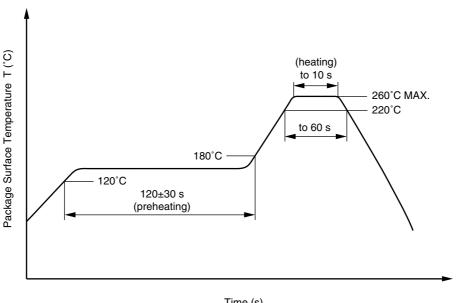
· Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

### Recommended Temperature Profile of Infrared Reflow



### Time (s)

### (2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

#### <R> (3) Soldering by soldering iron

• Peak temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

## NEC



## <R> USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



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M8E 02.11-1



NEC PS7241E-1B

### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
  - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

### ▶ For further information, please contact

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